



Serial No. 10/718,640

**IN THE SPECIFICATION:**

The specification as amended below with replacement paragraphs shows added text with underlining and deleted text with ~~strikethrough~~.

Please REPLACE paragraph [0090] on page 17 with the following amended paragraph:

**[0090]** As shown in FIG. 9, because ~~the first dummy apertures 213~~213a exist at the outermost edges of each of the mask units 21, the total pitch  $P_t$  is determined as the interval between lines C and D which connect the outermost first main apertures 211a of two mask units 21a in the x-axis direction. As shown in FIGS. 10A and 10B, the total pitch  $P_t$  may have a deviation ( $P_t \text{ max} - P_t \text{ min}$ ). As shown in FIGS. 10A through 10C, a line deviation ( $\Delta X$ ) may be generated. Hence, the evaporation mask 20 and the mask frame 30 must be welded together while controlling tension for local areas so as to reduce both deviation of the total pitch and line deviation.

Please REPLACE paragraph [00108] on page 21 with the following amended paragraph:

**[00108]** Although not shown in the drawings, at the same time the inter-insulator 64 is formed, a shielding wall may be further formed inside and outside a place to be coated with an adhesive agent so as to seal up a cap, and an outer-insulator may be formed between the first electrode line 61 and the second electrode terminal 52. As described later, the outer-insulator is formed to prevent problems such as disconnection due to the step difference between second electrode lines and the second electrode terminals 52 upon formation of the second electrode lines. A buffer layer may be further formed below the outer-insulator by processing the transparent conductive film 43 to improve the adhesive strength between the ~~outer-insulator~~outer-insulator and a substrate. Separators may be simultaneously formed to form an organic EL film and a pattern of second electrode lines. Partitions for preventing the organic EL film from being damaged may be formed simultaneously. Shielding portions may be formed simultaneously on the place to be coated with an adhesive agent.